

Missouri University of Science and Technology Scholars' Mine

Electrical and Computer Engineering Faculty Research & Creative Works

**Electrical and Computer Engineering** 

01 Jan 1995

# The Influence of PCI 3 on Planarisation and Selectivity of InP Regrowth by Atmospheric Pressure MOVPE

M. J. Harlow

P. C. Spurdens

Randy Hays Moss Missouri University of Science and Technology, rhm@mst.edu

Follow this and additional works at: https://scholarsmine.mst.edu/ele\_comeng\_facwork

Part of the Electrical and Computer Engineering Commons

# **Recommended Citation**

M. J. Harlow et al., "The Influence of PCI 3 on Planarisation and Selectivity of InP Regrowth by Atmospheric Pressure MOVPE," *Proceedings of the 7th International Conference on Indium Phosphide and Related Materials, 1995,* Institute of Electrical and Electronics Engineers (IEEE), Jan 1995. The definitive version is available at https://doi.org/10.1109/ICIPRM.1995.522146

This Article - Conference proceedings is brought to you for free and open access by Scholars' Mine. It has been accepted for inclusion in Electrical and Computer Engineering Faculty Research & Creative Works by an authorized administrator of Scholars' Mine. This work is protected by U. S. Copyright Law. Unauthorized use including reproduction for redistribution requires the permission of the copyright holder. For more information, please contact scholarsmine@mst.edu.

# The Influence of PCl<sub>3</sub> on Planarisation and Selectivity of InP Regrowth by Atmospheric Pressure MOVPE

M. J. Harlow, P. C. Spurdens and R. H. Moss

Technology Research Unit, BT Laboratories, Martlesham Heath, Ipswich, Suffolk, IP5 7RE, UK. E-mail: mike.harlow@bt-sys.bt.co.uk

man. mike.nariow@0t-sys.0t.co.u

# Abstract

The introduction of phosphorus trichloride into the AP-MOVPE growth of InP has been found to dramatically improve the regrowth adjacent to mesa structures. By suppressing growth in the [100] direction and enhancing growth in the [311] directions planar regrowth is achieved. Polycrystalline deposits on dielectric masks can also be completely suppressed.

## Introduction

Re-growth of InP onto lithographically defined non-planar structures, selective area epitaxy (SAE), is often a fundamental part of device fabrication. The morphology of this growth step influences both device performance and the ease with which subsequent processing steps can be carried out and in some cases dictates device architectures. In conventional atmospheric pressure MOVPE, growth adjacent to areas of dielectric is enhanced by migration of material from the vicinity of the dielectric to the semiconductor<sup>[1]</sup> giving rise to growth rate enhancement and 'ear' formation<sup>[2]</sup>. If the dielectric is wider than ~20 $\mu$ m then polycrystalline deposition is likely. Both 'ears' and polycrystalline deposits can seriously degrade subsequent lithographic and re-growth steps.

Considerable effort is being made world-wide, using a wide range of techniques, to develop routes to planar regrowth. Growth at reduced pressure can significantly improve selectivity and reduce growth rate enhancement<sup>[3]</sup>. Low pressure MOVPE at <10 Torr greatly reduces 'ear' growth. Further improvement is possible by going to still lower pressures and growing by Chemical Beam Epitaxy, CBE. By CBE, when conditions are optimised, growth on the dielectric can be eliminated. By Molecular Beam Epitaxy, MBE, growth occurs equally on semiconductor and dielectric unless impractically high temperatures are used.

An alternative approach to lowering the pressure is to modify growth chemistry at atmospheric pressure. There has been a revival in one of the original epitaxy techniques, Vapour Phase Epitaxy, VPE, and in particular Hydride VPE<sup>[4-7]</sup>. In this technique, hydrides are used to transport the group V elements but chlorides are used for the group III's. Selectivity of InP growth by HVPE is excellent with planar overgrowth of 14µm high dry etched mesas having been reported<sup>[8]</sup>. A modification of the VPE technique using group III alkyls and group V chlorides has recently been reported<sup>[9]</sup>.

The potentially more versatile technique is a modification to the MOVPE process by the addition of a chlorine containing compound. Using this method the growth chemistry can be modified to mimic HVPE while retaining the rapid switching, excellent compositional control, range of materials and uniformity of MOVPE in the same system. The simplest chlorine containing compound that could be added to the MOVPE reactor is hydrogen chloride, HCl, but it is known that HCl reacts with trimethylindium, TMIn, to form a low volatility white solid. The use of carbon tertrachloride, CCl<sub>4</sub>, has been reported<sup>[11]</sup> as has the use of 1, 1, 1 trichloroethane<sup>[12]</sup>. The use of group V chlorides have also been investigated, i.e. AsCl<sub>3</sub> in the growth of GaAs from TMGa and arsine, and PCl<sub>3</sub> in the growth of InP from TMIn and phosphine<sup>[13]</sup>.

The use of group V chlorides in the MOVPE process has been questioned because of parasitic reactions on mixing with group III alkyls<sup>[14]</sup>, however in our work, using PCl<sub>3</sub> in the growth of InP has not shown any problems.

#### Experimental

All growths were carried out in an atmospheric pressure MOVPE kit using TMIn in a stainless steel bubbler held at 40.0°C and 100% PH<sub>3</sub> in a high pressure cylinder. The PCl<sub>3</sub> was held in a borosilicate glass bubbler in a temperature controlled bath between 0°C and -30°C. Growth was in a horizontal, rectangular section, water cooled reactor with IR heating and three zone temperature control. Total gas flow was held near 7 l/min and all growth was on (100) substrates unless otherwise noted.

Four batches of reactive ion etched, RIE, vertical walled mesa stripes were prepared on (100) substrate or planar

material for use during the work. The initial batch of mesas were in both [011] and  $[0\overline{1}1]$  directions but all subsequent mesas were in the [011] direction only. The test samples each contained four different mesa widths, i.e. 2µm, 4µm, 6µm and 15µm wide and broad areas of dielectric mask 500µm wide. The mesas were 5.4µm high. One batch of mesas were prepared consisting of 5µm, 10µm, 15µm and 20µm wide square and circular pillars to investigate growth in both directions simultaneously. All mesas had silica dielectric masks on top during growth.

Analysis of growth was carried out using optical Nomarski microscopy, to show surface morphology and cleaved cross sections, and by Scanning Electron Microscopy, SEM. Cleaved sections were stained in a solution of potassium ferricyanide and potassium hydroxide, 1:2 by weight, under white light illumination. Atomic Force Microscopy, AFM, was carried out by AEA Technology.

#### Results

## General Features of Growth with PCl3

The use of PCl<sub>3</sub> in the growth of InP on (100) surfaces has two significant effects. Firstly, the growth rate is reduced in proportion to the concentration of PCl<sub>3</sub> as illustrated in Figure 1.



Figure 1. InP growth rate in the (100) direction with the addition of PCl<sub>3</sub>.

The second effect is the degradation of the surface morphology illustrated in Figure 2. Surface relief is approximately 30nm with slope angles of between  $2^{\circ}$  and  $3^{\circ}$  with the long axis of the features aligned with the [011] direction. Atomic Force Microscopy (AFM) images show that the features are terraced on the atomic scale with each step being of the order of  $3^{\circ}$ . It was found that the surface morphology could be improved by growing on mis-



Figure 2. (100) surface morphology of InP grown with PCl<sub>3</sub>. White bar is 500µm long

oriented substrates. Growth on  $(100) \xrightarrow{2^{\circ}} (110)$  resulted in smooth, specular morphology.

## **Mesa Regrowth**

The improvement of growth adjacent to mesas is illustrated in Figure 3. Growth at 600°C without PCl<sub>3</sub> results in



Figure 3. Effect of adding PCl<sub>3</sub> during regrowth of InP adjacent to RIE mesas. a) without PCl<sub>3</sub>, b) with PCl<sub>3</sub>

irregular overgrowth of the silica mask whereas with  $PCl_3$ growth is pinned to (111) planes at the mesa edge and terminates at the (100) surface. A range of growth temperatures were investigated and found to significantly affect the shape of the regrowth. At higher growth temperatures (700°C) the region of enhanced growth adjacent to the mesa became narrower but more pointed whereas at lower growth temperature (500°C) depressions appeared at the mesa edges. In both cases the surface morphology was seen to be smoother than at  $600^{\circ}$ C.

The influence of V/III ratio on growth was studied but found to be less important than growth temperature. As the V/III ratio was increased over the range 15 to 200 the regrowth features were seen to become more angular although the general form of the growth remained the same. The greatest effect of V/III ratio was seen at the lower growth temperature where the depressions at the mesa edge became much more pronounced.

Increasing the concentration of  $PCl_3$  during growth further reduces the growth rate enhancement near the mesa as illustrated in Figure 4, where the flow has been increased by a factor of 3.



Figure 4. Effect of increasing flow of PCl<sub>3</sub> on mesa regrowth at 600°C. a) 9x10<sup>-7</sup> moles min<sup>-1</sup> PCl<sub>3</sub>, b) 2.5x10<sup>-6</sup> mole min<sup>-1</sup> PCl<sub>3</sub>.

Complete suppression of growth in the [100] direction can be achieved by increasing the PCl<sub>3</sub> concentration to  $6\times10^{-6}$ moles min<sup>-1</sup>. Figure 5 shows one side of a 15µm wide 5.4µm high RIE mesa, regrown with the above PCl<sub>3</sub> concentration, with six alternating layers of p-type and ntype InP.



Figure 5. Regrowth of alternating p- and n-type InP around 5.4 $\mu$ m high mesas with 6x10<sup>-6</sup> moles min<sup>-1</sup> PCl<sub>3</sub>.

The growth from the sides of the mesa is seen to proceed on the (311) planes with a growth rate of 11.5 $\mu$ m hour<sup>-1</sup>. This form of growth is very similar to that seen in HVPE<sup>[14]</sup> and it is the presence of the fast growing (311) planes which is responsible for the complete suppression of growth in the [100] direction<sup>[15]</sup>.

Dopant incorporation during PCl<sub>3</sub> assisted regrowth is expected to differ from conventional regrowth as growth proceeds on (311) in preference to (100) surfaces and because of the higher growth rate<sup>[16-17]</sup>. As a result dopant precursor flows will have to be modified for regrowth using PCl<sub>3</sub>.

The PCl<sub>3</sub> assisted planarisation seen above has also been observed on mesas formed by wet etching and on in-situ etched mesas formed using PCl<sub>3</sub> etching before regrowth. In both cases growth stopped at the top of the mesa demonstrating that the planarisation is independent of the initial mesa shape.

The planarity of the regrowth is however found to depend on the mesa width and as the mesa width is increased beyond 15 $\mu$ m, growth in the [100] direction again becomes significant. Increasing the concentration of PCl<sub>3</sub> does not improve the growth but starts to degrade the surface by introducing etch pits. Improved growth on wide mesas can however be achieved by reducing the growth temperature and growth adjacent to 500 $\mu$ m wide 5.4 $\mu$ m high stripes has been observed with as little as 1.25 $\mu$ m excess growth above the top of the mesa. Thus the technique may also be applicable to butt-coupling in active-passive waveguide devices.

Regrowth of InP around pillars is illustrated in Figure 6.



Figure 6. An array of pillars after planarising regrowth with Fe-doped InP. The separation between centres of the devices is 125µm.

It can be seen that a square, planar region is formed adjacent to the pillar and that the extent of growth is similar in both [011] and  $[0\overline{1}1]$  directions. This behaviour is different to that seen in HVPE in which growth in the [011] direction is significantly faster than in the  $[0\overline{1}1]$  direction<sup>[14]</sup>.

#### Conclusions

The incorporation of PCl<sub>3</sub> into the AP-MOVPE process has been demonstrated to planarise regrowth adjacent to mesa structures up to  $15\mu$ m wide and completely suppress polycrystalline growth on dielectric masks over 500 $\mu$ m wide. The planar regrowth around pillars demonstrates that the vertical extent of the growth is the same in both [011] and [011] directions. By modifying the growth conditions, near planar regrowth can be achieved adjacent to tall mesa stripes up to 500 $\mu$ m wide.

#### References

[1] E. J. Thrush, J. P. Stagg, M. A. Gibbon, R. E. Mallard, B. Hamilton, J. M. Jowett and E. M. Allen, "Selective and non-planar epitaxy of InP/GaInAs(P) by MOCVD", Materials Science and Engineering B21 (1993) 130-146.

[2] J. L. Zilko, B. P. Segnar, U. K. Chakrabarti, R. A. Logan, J. Lopata, D. L. Van Haren, J. A. Long and V. R. McCrary, "Effect of mesa shape on the planarity of InP regrowths performed by atmospheric pressure and low pressure selective metalorganic vapor phase epitaxy", J. Crystal Growth **109** (1991) 264-271.

[3] N. Nordell and J. Borglind, "MOVPE growth of InP around reactive ion etched mesas", J. Crystal Growth 114 (1991) 92-98.

[4] O. Kjebon, S. Lourdudoss, B. Hammarlund, S. Lindgren, M. Rask, P. Ojala, G. Landgren and B. Broberg, "1.55µm buried heterostructure laser via regrowth of semiinsulating InP:Fe around vertical mesas fabricated by reactive ion etching using methane and hydrogen", Appl. Phys. Lett. **59**(3) 253 (1991).

[5] B. Hammarlund, S. Lourdudoss and O. Kjebon, "Orientation dependent growth behaviour during hydride VPE regrowth of InP:Fe around reactive ion etched mesas", J. Elect. Materials **20**(7) 523 (1991).

[6] O. Kjebon, S. Lourdudoss and J. Wallin, "Regrowth of semi-insulating iron doped InP around reactive ion etched laser mesas in (110) and  $(\overline{1}10)$  directions by hydride

vapour phase epitaxy", Proc. 4th Int. Conf. InP & Related Materials, Cardiff, 1992. p. 48-50.

[7] S. Lourdudoss, O. Kjebon, J. Wallin and S. Lindgren, "High-frequency GaInAsP/InP laser mesas in (110) direction with thick semi-insulating InP:Fe", IEEE Photonics Technology Lett. 5(10) 1119 (1993).

[8] S. Lourdudoss, K. Streubel, J. Wallin, J. André, O. Kjebon and G. Landgren, "Very rapid and selective epitaxy of InP around mesas of height up to  $14\mu$ m by hydride vapour phase epitaxy", Proc. 6th Int. Conf. InP & Related Materials, Santa Barbara, 1994. p. 615-618.

[9] S. Kondo, S. Matsumoto and H. Nagai, "Metalorganic chloride vapor phase epitaxial growth of III-V compounds in a single reactor", J. Crystal Growth 132 (1993) 305-314. [10] N. Nordell and J. Borglind, "Improved InP regrowth property in MOVPE by addition of  $CCl_4$ ", Appl. Phys. Lett. 61, 21-24 (1992).

[11] B. -T. Lee, R. A. Logan, R. F. Karlicek, Jr. "Planar regrowth of InP and InGaAs around reactive ion etched mesas using atmospheric pressure metalorganic vapor phase epitaxy", Appl. Phys. Lett. **63**(2) 234 (1993).

[12] R. Azoulay and L. Dugrand, "Selective growth of GaAs by organometallic vapor phase epitaxy at atmospheric pressure", Appl. Phys. Lett. 58(2) 128 (1991).

[13] D. Robein, B. Rose, M. McKee, R. Mellet, D. Walker, H. Mani, J. Charil and P. Norris, "Selective area epitaxy on InP substrates: A comparison of growth behaviour at low and atmospheric pressure", European Workshop MOVPE IV, Poster 47.

[14] S. Lourdudoss, E. Rodriguez Messmer, O. Kjebon, K. Streubel, J. Andre, G. Landgren, "Morphological modifications during selective growth of InP around cylindrical and parallelopiped mesas", Materials Science and Engineering **B28**(1994) 179

[15] B. -T. Lee, R. A. Logan, "Growth of InP on etched grooves using atmospheric pressure metalorganic vapor phase epitaxy", J. Crystal Growth **140** (1994) 1-8.

[16] P. R. Berger, S. N. G. Chu, R. A. Logan, E. Byrne, D. Coblentz, J. Lee III, N. T. Ha, N. K. Dutta, "Substrate orientation effects on dopant incorporation in InP grown by metalorganic chemical vapor deposition", J. Appl. Phys. **73**(8) 1993, 4095.

[17] R. Bhat, C. Caneau, C. E. Zah, M. A. Koza, W. A. Bonner, D. M. Hwang, S. A. Schwarz, S. G. Menocal, F. G. Favire, "Orientation dependence of S, Z, Si, Te and Sn doping in OMCVD growth of InP and GaAs: application to DH lasers and lateral p-n junction arrays grown on non-planar substrates", J. Crystal Growth **107** (1991) 772-778.